

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JEONG SU CHOI</td> <td>02/10/2014</td> </tr> <tr> <td>WON SEOK LEE</td> <td>02/10/2014</td> </tr> <tr> <td>SEOK GOO JANG</td> <td>02/10/2014</td> </tr> <tr> <td>ROO DA LEE</td> <td>02/10/2014</td> </tr> <tr> <td>SANG HOO PARK</td> <td>02/10/2014</td> </tr> <tr> <td>KEUN HOON YOO</td> <td>02/10/2014</td> </tr> </tbody> </table>		Name	Execution Date	JEONG SU CHOI	02/10/2014	WON SEOK LEE	02/10/2014	SEOK GOO JANG	02/10/2014	ROO DA LEE	02/10/2014	SANG HOO PARK	02/10/2014	KEUN HOON YOO	02/10/2014
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RECEIVING PARTY DATA															
Name:	LG CHEM, LTD.														
Street Address:	128, YEOUNI-DAERO, YOUNGDUNGPO-GU														
City:	SEOUL														
State/Country:	KOREA, REPUBLIC OF														
Postal Code:	150-721														
PROPERTY NUMBERS Total: 1															
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14183204</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14183204										
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Application Number:	14183204														
CORRESPONDENCE DATA															
Fax Number:	(202)496-7756														
Phone:	2024967500														
Email:	mlaip@mckennalong.com														
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>															
Correspondent Name:	MCKENNA LONG & ALDRIDGE LLP														
Address Line 1:	1900 K STREET NW														
Address Line 2:	IP DEPARTMENT														
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20006														
ATTORNEY DOCKET NUMBER:	29137.01421.US00														

NAME OF SUBMITTER:	MARK R. KRESLOFF
Signature:	/Mark R. Kresloff##42,766/
Date:	02/18/2014
Total Attachments: 2 source=2913701421US00ASS#page1.tif source=2913701421US00ASS#page2.tif	

## Assignment of Application

WHEREAS, I (WE)	<b>CHOI, Jeong Su; LEE, Won Seok; JANG, Seok Goo; LEE, Roo Da; PARK, Sang Hoo; YOO, Keun Hoon</b>
	, respectively,
have invented certain new and useful improvements in:	
<b>TRANSPARENT THERMOPLASTIC RESIN COMPOSITION AND MOLDED ARTICLE PREPARED THEREFROM</b>	
for which an application for Letters Patent was executed on	

(Application No. _____	, Filed _____	), and
WHEREAS, <b>LG CHEM, LTD.</b>	(hereinafter referred to as "ASSIGNEE") having a place of business at: <b>20 Yoido-dong Youngdungpo-gu, Seoul 150-721 Republic of Korea</b>	

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and Its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.



The undersigned hereby grant(s) the firm of McKenna Long & Aldridge LLP, Attorneys at Law, 1900 K Street, N.W., Washington, D.C. 20006 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: 2-10/2014 최정수  
(Signature of Inventor)  
CHOI, Jeong Su

Date: 2-10/2014 이원석  
(Signature of Inventor)  
LEE, Won Seok

Date: 2-10/2014 장석구  
(Signature of Inventor)  
JANG, Seok Goo

Date: 2-10/2014 이루다  
(Signature of Inventor)  
LEE, Roo Da

Date: 2-10/2014 S.H. Park  
(Signature of Inventor)  
PARK, Sang Hoo

Date: 2-10/2014 이훈훈  
(Signature of Inventor)  
YOO, Keun Hoon

**McKenna Long & Aldridge LLP**  
Attorneys At Law  
1900 K Street, N.W.  
Washington, D.C. 20006

